



Click [here](#) for the 3D model.

### Dimensions

Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
T	1.25mm +/-0.15mm
B	0.7mm +/-0.35mm

### Packaging Specifications

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

### General Information

Series	SMD Auto COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable, Automotive Grade
Features	FT-CAP, Ultra-Stable, Automotive Grade
RoHS	Yes
Termination	Flexible Termination
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	67 mg
Shelf Life	78 Weeks
MSL	1

### Specifications

Capacitance	0.056 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	1%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	17.8571 GOhms